

Development of a GridPix readout for a TPC at the International Linear Collider

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A Gridpix TPC readout for the ILC (Kees Ligtenberg)

The International Linear Collider

- The ILC is a proposed Linear electron-positron collider with polarized beams
- A first stage as a 250 GeV Higgs factory
- Extendable to higher energies of 500+ GeV
- Clean environment allows for precise detectors and measurements



Some physics goals of the ILC

- What is the origin of EWSB?
- How can the Higgs bosons be so light? What is dark matter made of?
- Are there more Higgs bosons?



The International Large Detector

- ILD is a detector concept for ILC
- The ILD uses a TPC as the central tracker to measure the momentum of particles
- TPC (gaseous detector) advantages
 - Minimal material budget and very homogenous ⇒ Little scattering
 - Many hits per track ⇒ effective track finding
 - Particle identification by dE/dx
 - Cost effective



Readout technologies for ILD TPC







Pads with GEMs or Micromegas for amplification \rightarrow Detect charge spread



Pixels readout with integrated aligned amplification grid (Gridpix)

→ detect each single electron Maximal possible information from track

Detector setup at Bonn test beam (2017)

- A Timepix3 based Gridpix with SPIDR readout
 - Simultaneous data-driven detection of time and time over threshold (charge) allows for timewalk corrections
 - Higher rates and more precise (1.56 ns time resolution) compared to its predecessor Timepix1



See also paper on this testbeam: <u>https://doi.org/10.1016/j.nima.2018.08.012</u>



Detector with guard and field shaper



Map of Timepix3 hits



- Successfully measured a large number of hits
- The chip and grid have some small defects



Single hit resolution in pixel plane



Single hit resolution in pixel plane: $\sigma_y^2 = \sigma_{y0}^2 + D_T^2(z - z_0)$

Depends on:

- $\sigma_{y0} = \text{pixel size } / \sqrt{12}$
- Diffusion D_T from fit

Note that:

- A hit resolution of ~250 μm is ~25 μm for a 100-hit track (~ 1 cm track length)
- At $B=4~{
 m T}$, $D_T=25~{
 m \mu m}/{\sqrt{{
 m cm}}}$

Deformations in pixel plane and drift direction

- For applications in a large TPC, systematic deviations must be well under control
- Each bin displays mean of residuals from 4×4 pixels at expected position
- The RMS of the mean residuals is 7 μm in the pixel plane, and 21 μm (0.3 ns) in the drift direction \Rightarrow Overall grid quality is very good



Particle identification by dE/dx

Find the energy loss (dE/dx) by truncated sum:

- Merge 83 single chip events together to make one track of 1 meter
- Count the number of hits per intervals of 20 pixels
- Reject the top 10% of intervals with the most hits and sum the other 90% into a truncated sum

There is a 8.8 σ separation between a 2.5 GeV electron and minimum ionizing particle

The resolution (RMS/mean) is 4.1% for an effective track length of 1 m (\approx ILD TPC effective track length)



Quad module development

- Developed a 4-chip module with all services under the active area
- Active area coverage is 70% (Through-silicon via technology might increase this)
- Can be used as a building block to cover arbitrarily large TPC areas



Quad tested with electron beam at Bonn (2018)

- Also tested in another test beam with 2.5 GeV electrons at the ELSA Facility in Bonn on 4-5 October 2018
- Analysis just started...



Performance of a GridPix TPC at ILC

- From full DD4HEP (Geant4) simulation, momentum resolution can be determined
- Momentum resolution is \geq 20% better (scaled from 100% coverage)



2 - 11 - 2018

Conclusions

- The ILC can do measurement on the Higgs boson with great precision
- With a GridPix readout the ILD TPC performance can be improved
- A GridPix based on the Timepix3 chip was reliably operated in a test beam setup and has a resolution only limited by diffusion
- A Quad module is built and data from a test beam is now under investigation

Backup

Run parameters and selection

- Use run with the highest single electron efficiency (close to 1)
- Use basic selection cuts to find clean tracks (69% efficiency)
- Drift velocity for T2K gas from Magboltz was 78.9 μ m/ns (consistent with data)



Time walk correction

3⊦

2

n



Time walk error: time of arrival depends on signal amplitude

Time walk can be corrected using Time over Threshold (ToT) as a measure for signal strength

1.5

C₁

t_o

0.525 mm us

-0.0102 μs

2

ToT [µs]

First order correction fitted and applied:

$$\delta z_{\text{timewalk}} = \frac{c_1}{t_{ToT} + t_0} + z_0$$

0.5



Residual distribution improved

Higher order corrections were also tried but did not yield further improvements

Single hit resolution in drift direction



Single hit resolution in drift direction $\sigma_z^2 = \sigma_{z0}^2 + D_L^2(z - z_0)$

Depends on

- + σ_{z0} from fit
- Diffusion D_L from fit

Because of a large time walk error in hits with a low signal strength, an additional ToT cut (>0.60 μs) was imposed

Mean residuals from test beam

- For applications in a large TPC, systematic deviations must be well under control
- Each bin displays mean of residuals from 4 × 4 pixels
- 1 mm from the edges distortions are below 30 μm



Too small number of hits in first and last 8 columns (at edge) Mean residual above 100 μm for columns 8-16, 240-248 From column 16-240, residuals are below 30 μm Bottom right is damaged Top left has distortions of 60 μm



Distortions at the edges due to variation of guard voltage

In the deformation plot, the attraction of hits to the guard is visible near the edges



The Projection of selected bins 1-3.5 mm from the edge, shows that deformations are below +-50 μ m for +- 10 V



Chip placement requirements in Quad design

- To design a precise module with multiple chips, the electric field behavior at edges is studied with simulations
- Hit deviations are calculated for different distances between chip edges
- For the top curve with 2 pixels (110 μm) distance, deviations < 20 μm are found > 1 mm from the edge
- Larger distances must be bridged with a guard structure
- The Quad module is designed for these stringent requirements on chip placement:
 - chip-chip distance < 100 μ m
 - guard height precise at 20 μm level



Energy loss resolution by cluster counting

- With the pixel granularity ionization clusters can be partially resolved
- This gives the possibility to improve the dE/dx resolution by cluster counting
- Various algorithms were tried
- Weighted mean distance between hits is a good measure of dE/dx
- Use (actual/Poisson)-fluctuation as weights
- 2.7% resolution or 9.2 σ separation between MIP and 2.5 GeV electron



Outlier rejection



Telescope
At least 4 planes hit
Reject outliers (>700 μm)
Telescope track goes through TPC
GridPix detector
Hit ToT > $0.15 \mu s$
At least 30 hits
Reject outliers (> $3\sigma_{drift}$, > $2\sigma_{plane}$)
At least 75% of total number of GridPix hits in fit
Track projection crosses first and last pixel column
Matching of telescope and GridPix detector
Tracks closer than 1 mm at center of TPC
A unique track pair match

Scatter at last telescope plane (2017)

- Telescope setup was not optimal in 2017: detector was not between planes
- Multiple scattering of ~0.7 mrad at last telescope plane
- Only a reliable intercept with 10 μm error from the telescope

Scatter caused broadening of residual distribution

Simulation of ILD TPC with pixel readout

- To study the performance of a large pixelised TPC, the pixel readout was implemented in the full ILD DD4HEP (Geant4) simulation
- Changed the existing TPC pad readout to a pixel readout
- Adapted Kalman filter track reconstruction to pixels

See also LCTPC-WP meeting 11-05-17, (The problem with pulls is solved)